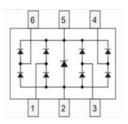


Discription

The HAOZ8905CI is a 5-channel ultra low capacitance rail clamp ESD protection diodes array. Each channel consists of a pair of ESD diodes that steer positive or negative ESD current to either the positive or negative rail. A zener diode is integrated in to the array between the positive and negative supply rails. In the typical applications, the negative rail pin (assigned as GND) is connected with system ground. The Positive ESD current is steered to the ground through an ESD diode and Zener diode and the positive ESD voltage is clamped to the zener voltage.

65 4 2 3

SOT-23-6L



Circuit Diagram

Features

- ★ 5 channels of ESD protection
- ★ Provides ESD protectionto IEC61000-4-2 level 4
 - ±27kV air discharge
 - ±15kV contact discharge
- ★ Channel I/O to GND capacitance: 0.4pF(Max)
- ★ Channel I/O to I/O capacitance: 0.8pF(Max)
- ★ Low clampingvoltage
- ★ Low operating voltage
- ★ Improved zener structure
- ★ Optimized package for easyhigh speed data lines PCB layout
- * RoHS compliant.

Orderingin formation

Product ID	Pack	Qty(PCS)
HAOZ8905CI	SOT-23-6L	3000

Absolute Ratings(Tamb = 25°C)

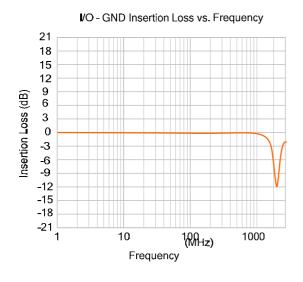
Characteristics	Symbol	Ratings	Unit
Peak Pulse Power(8/20µs)	P _{PP}	55	W
Peak Pulse Current(8/20µs)	I _{PP}	4	А
ESD per IEC 61000-4-2(Air)	V _{ESD1}	±20kV	kV
ESD per IEC 61000-4-2(Contact)	V _{ESD2}	±15kV	kV
Operating Temperature Range	Topr	-55 ~ +125	°C
Storage Temperature Range	Tstg	-55 ~ +150	°C

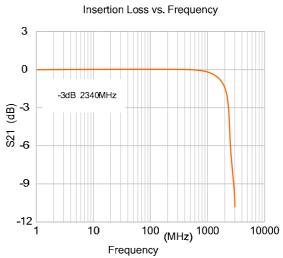


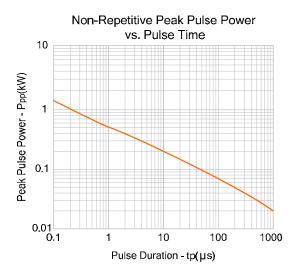
Electrical Characteristics (Tamb=25°C)

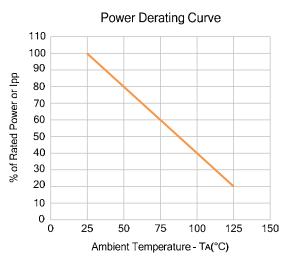
Characteristics	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Reverse Working	V_{RWM}	Any I/O pin to GND			_	V
Voltage					5	V
Reverse Breakdown	V_{BR}	I _t =1mA;	6			V
Voltage		Any I/O pin to GND				٧
Reverse Leakage	I _R	V _{RWM} =5V, T=25°C;			1	μA
Current		Any I/O pin to GND				
Desitive Clamping	amping V _{C1}	$I_{PP}=4A$, $t_{P}=8/20 \mu s$;				
Positive Clamping		Positive pulse;		8.5	12.0	V
Voltage		Any I/O pin to GND				
Negative Clamping		I _{PP} =4A, t _P =8/20μs;				
Negative Clamping	V _{C2}	Negative pulse;		1.8		V
Voltage		Any I/O pin to GND				
Junction Capacitance	C _{J1}	V _R =0V, f=1MHz;		0.3	0.4	pF
Between Channel		Between I/O pins				
Junction Capacitance	C _{J2}	V _R =0V, f=1MHz;		0.6	0.8	pF
Between I/O And GND		Any I/O pin to GND				

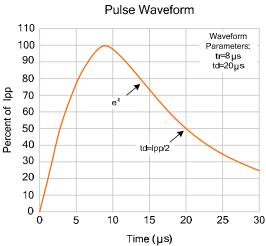
Typical Characteristics

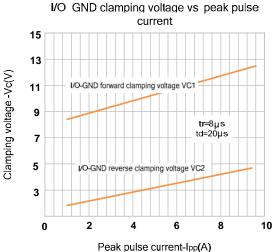


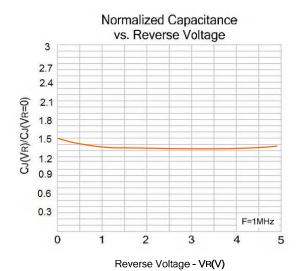




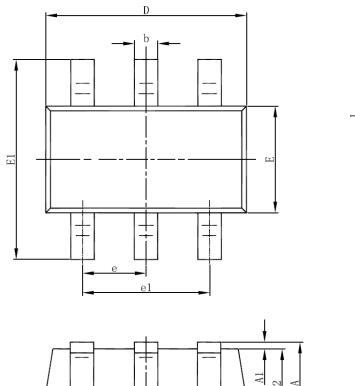


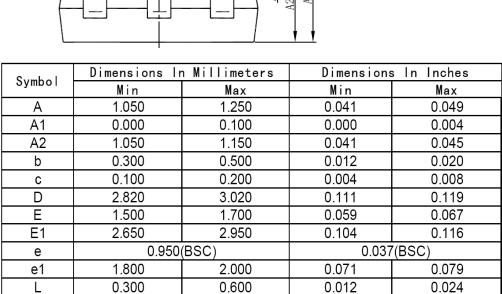






SOT-23-6L Package Information





8°

0°

8°

θ

0°



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